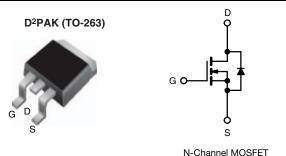
Vishay Siliconix

COMPLIANT HALOGEN

FREE

D Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	450			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.6		
Q _g max. (nC)	30			
Q _{gs} (nC)	4			
Q _{gd} (nC)	7			
Configuration	Single			



FEATURES

- · Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): $R_{on} \times Q_{g}$
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB10N40D-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	400	
Gate-Source Voltage			V	± 30	V
Gate-Source Voltage AC (f > 1 Hz)			V _{GS}	30	
Continuous Drain Current (T _J = 150 °C)	\/ at 1	$\begin{array}{c c} T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} \end{array}$	- I _D	10	
	V _{GS} at 1	$T_{\rm C} = 100 {\rm ^{\circ}C}$		6	Α
Pulsed Drain Current ^a			I _{DM}	23	
Linear Derating Factor				1.2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	194	mJ
Maximum Power Dissipation			P _D	147	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	Т	_J = 125 °C	al\//al±	24	\//no
Reverse Diode dV/dt ^d			dV/dt	0.6	- V/ns
Soldering Recommendations (Peak temperatur	e) ^c	for 10 s		300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_q = 25 Ω , I_{AS} = 13 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.85	G/ VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	١	$I_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$		-	1 10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{\rm DS} = 320 \text{ V}$ $V_{\rm GS} = 10 \text{ V}$	$I_D = 5 \text{ A}$	-	0.5	0.6	Ω
Forward Transconductance	9fs		= 50 V, I _D = 5 A	_	2.7	-	S
Dynamic	9fs	V DS	= 50 V, ID = 5 A		2.1		
Input Capacitance	C _{iss}	T		_	526	T _	
Output Capacitance	Coss	┪ 、	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		59	_	pF
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		-	9	_	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	66	_	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	84	-	
Total Gate Charge	Qg			-	15	30	1
Gate-Source Charge	Q _{qs}	V _{GS} = 10 V I _D = 5 A, V _{DS} = 320 V	-	4	-	nC	
Gate-Drain Charge	Q _{gd}			-	7	-	1 !
Turn-On Delay Time	t _{d(on)}	V _{DD} = 400 V, I _D = 10 A,		-	12	24	ns
Rise Time	t _r			-	18	36	
Turn-Off Delay Time	t _{d(off)}		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		18	36	
Fall Time	t _f	1		-	14	28	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.9	1.8	3.6	Ω
Drain-Source Body Diode Characteristic	s	_					
Continuous Source-Drain Diode Current	I _S	MOSFET sym	MOSFET symbol showing the		-	10	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	40	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 25 \text{ V}$		-	230	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.6	-	μC
Reverse Recovery Current	I _{RRM}			_	14	_	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

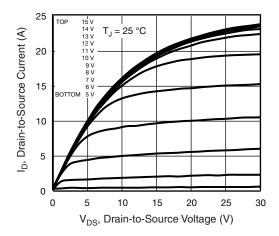


Fig. 1 - Typical Output Characteristics

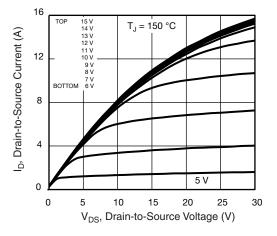


Fig. 2 - Typical Output Characteristics

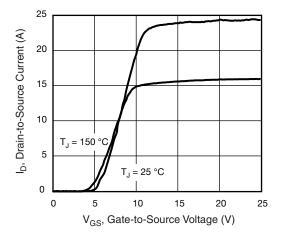


Fig. 3 - Typical Transfer Characteristics

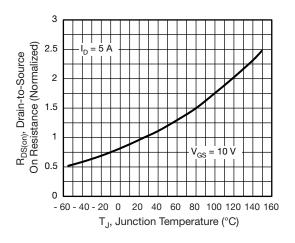


Fig. 4 - Normalized On-Resistance vs. Temperature

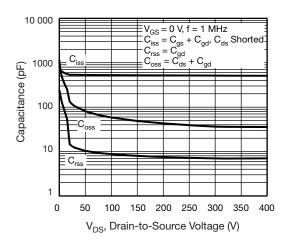


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

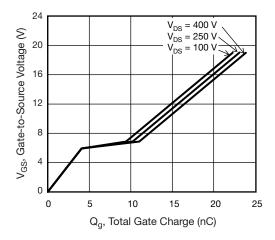


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



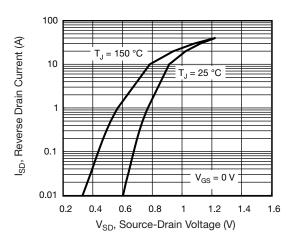


Fig. 7 - Typical Source-Drain Diode Forward Voltage

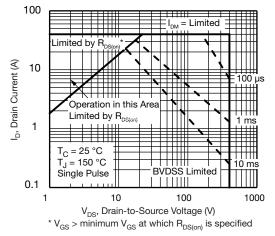


Fig. 8 - Maximum Safe Operating Area

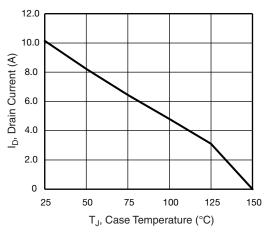


Fig. 9 - Maximum Drain Current vs. Case Temperature

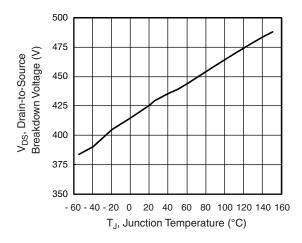


Fig. 10 - Temperature vs. Drain-to-Source Voltage

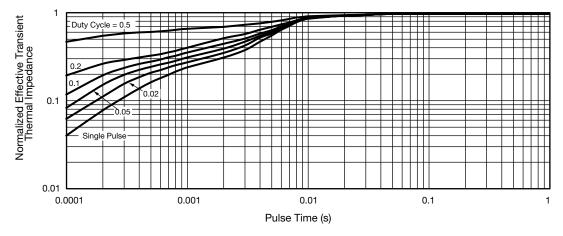


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

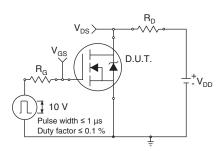


Fig. 12 - Switching Time Test Circuit

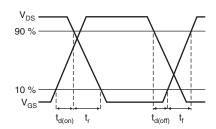


Fig. 13 - Switching Time Waveforms

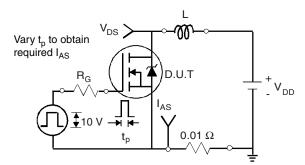


Fig. 14 - Unclamped Inductive Test Circuit

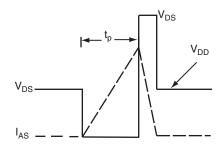


Fig. 15 - Unclamped Inductive Waveforms

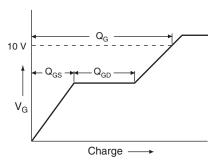


Fig. 16 - Basic Gate Charge Waveform

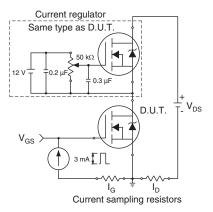
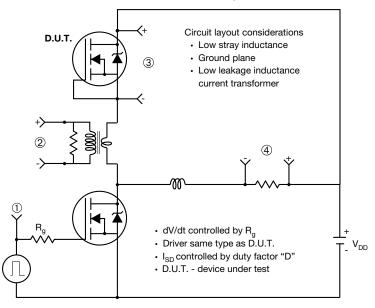


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



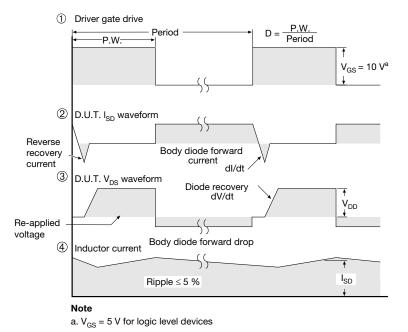


Fig. 18 - For N-Channel

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